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SMALL MULTIMODE ANTENNA AND HIGH FREQUENCY MODULE USING IT <u>B</u>

cles is set up at one end of a radiating conductor 1, a (57) A small multi-mode antenna in which a single feeding point can be used commonly for multiple frequonclos and an RF modulo using such antenna for use in loss-costly and small multimedia wireless apparatus is provided. The entenna is configured such that a single feeding point 4 which is common for multiple frequenfirst one-port resonant circuit 2 is connected to the one

end thereof, and a second one-port resonant circuit 3 is from the feeding point 4 toward frea space equaling the characteristic admittance 5 in the RF circuit, a susceptance component of the admittance is canceled out by the resonant circuit 2 connected to the feeding point With a conductance component of admittance in view connected to the other end of the radiating conductor 4 for muttiple frequencles.

RESONANT CIRCUIT TIUSRIS

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Description

Technical field

The present invention relates to an antenna of magnetic waves with different frequencies, the invention less apparatus that implements a plurality of services by relates to a multi-mode antenna applied to the wireless wireless apparatus that provides the user with multi-me dia services and a RF (Radio Frequency) module including the antenna. In particular, for use in multimedia wire-Information transmission through the media of electroapparatus and a multi-mode compatible RF module including the antenna.

Background Art

ers are required to have different wireless apparatuses terms of transferring and providing various kinds of information by way of radio transmission are getting more active lately and a great number of wireless apparatuses services are diversified year after year, involving telephones, TVs, Local Area Networks (LANs), etc. End ushave been devaloped and put into practical use. These providing services different services to receive all services. Mullimedia services

inywhere, namely, in a ubiquitous manner, thus making With the aim of improving the usability of end users who receive such services, attempts have already started to provide the services to end users anythne and the presence of media transparent to the users. A single erminal apparatus that implements a plurality of infornation transfer services, namely, a so-called multimode terminal is realized, but partially.

service. Therefore, a multi-media terminal is required to [0004] Because a ubiquitous information transmission service by ordinary radio transmission uses elecromagnetic waves as its medium, a plurality of services are provided to end users by using several frequencies n a same service area; one frequency for one type of have capability of transmitting and receiving multiple fre-

quencies of electromagnetic waves that are used for sters to a few meters. Consequently, the dimension of method in which a plurality of single-mode antennas, each provided for one frequency, are installed on a sined to install the antennas separated each other by a distance equivalent to wavelength to make each singlemode antenna operate Independently. Because the frenission are limited to a range from a few hundred MHz to a few GHz due to the limitation of their free space rated each other by a distance of a few tens of centimthe terminal becomes targe and portability for the user gle wireless apparatus is used. In this method, it is need services in terms of normal ubiquitous information trans propagation characteristic, the antennas must be sepa multimedia conventional ğ

by a distance, it is needed to install separate RF ctrcults connecting to the antennas for each frequency.

dimensions allowing for portability for the user is around formation services or a significant increase in the termi-nal weight due to increased bettery volume end poses 0006] For this reason, it is difficult to apply semiconductor integration circuit technology and there arises a problem of high-cost RF circuits as well as the increased dimensions of the terminal. Even when the RF circuits are integrated into a whole by applying the integration circuit technology with great efforts, there is a need for connecting the RF circuit to the individual antennas sep arated by a distance with RF cables. By the way, the diameter of the RF cable applicable to a terminal with one millimeter. Consequently, transmission loss of the RF cable in the current situation reaches a few dB/m With the use of such RF cable, power consumed by the RF circuit increases. This causes a significant decrease In use duration of the terminal providing ubiquitous ina problem of significantly degrading the usability for the user of the terminal.

which transmits at one frequency and the other end is [0007] Aside from the foregoing, two-frequency duplex antennas in which one end of a loop antenna or the material of the antennal is connected to a transmitter connected to a receiver which receives at the other frequency are disclosed (e.g., Japanese Patent Laid-Open No. S61(1986)-295905 and Japanese Patent Laid-Open No. H1(1989)-158805).

[0008] A two-frequency duplex anterma described in Japanese Patent Laid-Open No. S61(1989)-295905 is configured such that first and second resonant circuits respectively connected to either ends of the loop antenna which is a radiating conductor resonate with the loop nates at a transmit frequency and the other resonator at the other terminal resonates at a receive frequency, and the transmitter is connected to the one terminal and the antenna, wherein one resonator at one terminal reso receiver is connected to the other terminal.

Another two-frequency duplex antenna de-158805 is configured such that a first resonant circuit ion conductor and a transmit output terminal, assumes terminal of the material of the antenna and a receive inscribed in Japanese Patent Laid-Open No. H1(1989) resonaling at a transmit frequency, connected betweer one end of the material of the antenna which is a radia a high impedance to a receive frequency and discon nects the material of the antenna from the transmit out the receiving frequency, connected between the othe put terminal, assumes a high impedance to e transmi requency and disconnects the material of the enterna put terminal, and a second resonant ctrcuit resonatin

of these two-frequency duplex antennas, it is needed to provide the transmitter and the receiver for each of Input Even for a wireless apparatus employing either and output terminals (feeding points) located at sepa

s not satisfied. Because the antennas sensitive to dif-

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ate positions for different frequencies. Thus, it is difficult to integrate both, which makes e bottleneck in downsizng the wireless apparatus.

Disclosura of Invention

impedance in free space and the characteristic impedance in the RF circuit of the wireless apparatus for elecmagnetic waves with multiple frequencies. The multimode antenna is a single structure that realizes a superior matching characteristic between the characteristic [0011] One of key devices of a multimedia wireless apparatus is a mulii-mode antenna sensitive to electrotromagnetic waves with multiple frequencies.

the single feeding point. In consequence, semiconduc-tor integration circuit technology can be applied and, therefore, RF circuit downsizing can be achieved and a [0012] If, in such multi-mode antenna, a same feading point (input-output terminal) can be set up for electromagnetic waves with different frequencies, RF circuits small and less costly RF module compatible with multithat process multiple frequencies are allowed to share ple frequencies can be realized.

a small multi-mode antenna in which e single feeding point can be used commonly for multiple frequencies in less apparatus, and to provide a small RF module using [0013] Objects of the present invention are to provide order to realize a less costly and small multimedia wirethe multi-mode antenna.

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Ħ [0014] To achieve the above objects, a mutil-mode resonant circuit connected to one and of the radialing gle feeding point which is common for the plurality of frequencies and connected to the first one-port resonant prising a radiating conductor which radiates electromagnetic waves with a plurality of frequencies for which the antenna should operate, a first one-port (two-terminal) conductor, a second one-port resonant circuit connected to the other end of the radiating conductor, and a sinantenna of the present invention has a structure com-

ę a plurality of input-output terminals (feeding points), fiput terminal) for e plurality of different frequencies, a plurality of RF circuits that process multiple frequencies can be integrated and downstzing and cost reduction of the plurality of RF circuits are realized, and, moreover, the antenna itself can be made smaller because of including the single feeding point only. In the case of prior art antennas, to ensure electrically independent operations of nite space is required between the terminats and provision of such space has been a bottleneck in downsizing In the multi-mode antenna having such structure, because there is the same feeding point (input-out-[0015]

2 The reason why the single feeding point could be set up for multiple frequencies in the present invention is owing to the invention of a new resonant circuit dasign technique different from the prior art. Resonant circuits included in the multi-mode antenna of the [0016]

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ductor and a plurality of resonant circuits connected to It operate in unison. In consequence, taken as a whole, the single feeding point of the multi-mode antenna assumes an impedance matching with the impedance in the RF circuit for multiple frequencies, and matching between the characteristic impedance in free space and the characteristic impedance in the RF circuit is atpresent invention do not perform action which has been applied in prior art, i.e., a resonant circuit is opened or short-circuited for a certain frequency and electrically disconnects a part of the radiating conductor from the other part, instead, in this invention, the radiating conDesigning the resonant circuits according to ing conductor is regarded as a distributed resonant cir-cuit comprising a capacitance component with a resistresonant circuits shown in these figures and the radiatthe present invention is performed such that the radiatance component and an inductance component. According to the design method of the present invention. for example, for the structures shown in FIG. 11A, 11B, and 11C, subject to the vatues of the elements of the ing conductor dimensions, with regard to two-mode operation for 1 GHz and 2 GHz, good impedence matching equal to or less than a standing wave ratio of 2 (VSWR c2) is ensured over bandwidths of 3% and 5.5% respeclively for the above frequencies and bands. [0017]

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Brief Description of Drawings

[0018]

FIG. 1 is a structural diagram to explain one embod-Iment of a multi-mode antenna of the present inven-

FIG. 2 is a Smith chart to explain the characteristics of resonant circuits of the multi-mode antenna; FIG. 3 is a curve graph chart to explain a reactance function of the resonant circuits of the multi-mode

FIG. 4 is a structural diagram to explain another mutti-mode antenna embodiment of the present in-

multi-mode antenne embodiment of the present in-FIG. 5 is a structural diagram to explain another

multi-mode anterms embodiment of the present in-FIG. 6 is a structural diagram to explain anothe

multi-mode antenna embodiment of the present in-FIG. 7 is a structural diagram to explain another vention:

FIG. 8 is a structural diagram to explain another mutti-mode antenna embodiment of the present in

multi-mode antenna embodiment of the present invantion; FIG. 9 is a structural diagram to explain another

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FIGS. 10A1, 10A2, 10B1, and 10B2 are circuit schematics to explain the resonant circuits for use in the mutti-mode antenna of the present invention; multi-mode antenna embodiment of the present in-FIG. 11A is a perspective view to explain another

FIGS, 118 and 11C are circuit schemetics to explain the resonant circuits employed in the embodiment

FIG. 12A is a perspective view to explain another shown in FIG. 11A;

FIGS. 12B and 12C are circuit schematics to exmulti-mode entenna embodiment of the present in-

plain the resonant circuits employed in the embod-FIG. 13 is a perspective view to explain anothermul-(I-mode antenna embodiment of the present inven-Iment shown in FIG. 12A;

FIG. 14 is a perspective view to explain another

multi-mode antenna embodiment of the present in-FIG. 15 is a perspective view to explain another

FIG. 16 is a development view to explain anomutti-mode antenna embodiment of the present in-

thermutti-mode antenna embodiment of the present

thermulti-mode antenna embodiment of the present FIG. 17 is a development view to explain eno-

FIG. 18 is a development view to explain anothermulti-mode antenna embodiment of the present

multi-mode entenna embodiment of the present in-FIG. 19 is a development view to explain another

FIG. 21 is a development view to explain another multi-mode antenna embodiment of the present in-FIG. 20 is a development view to explain another

multi-mode antenna embodiment of the present in-FIG. 22A is a top view to explain an embodiment of

FIG. 22B is a bottom view of the RF module shown an RF module of the present invention;

FIG. 23A is a top view to explain another RF module embodiment of the present invention;

FIG. 24A is a top view to explain another RF module FIG. 23B is a bottom view of the RF module shown h FIG. 23A.

FIG. 24B is a bottom view of the RF module shown embodiment of the present invention; and

Best Mode for Carrying Out the Invention

(0019) The multi-mode antenna end the RF module

ings, functionally identical components are assigned the using it in accordance with the present invention will be described hereinafter more fully with reference to several embodiments shown in the drawings, in the drawsame reference numbers and their explanation is not re-

tenna embodiment of the present invention and their tively, to explain the characteristics of resonant circuits [0020] One embodiment of the present invention is described with FIGS. 1, 2, and 3. FIG. 1 is a structural diagram showing the components of a multi-mode anconnections. FIG. 2 and FIG. 3 are a Smith chart and a reactance function characteristic graph chart, respec-

onent circuit 2 are connected functions as a shigle feed-ing point 4. To the feeding point 4, an RF circuit repre-sented as a series equivalent circuit consisting of a chara first one-port resonant circuit 2 is connected between one end of a radiating conductor 1 which radiates elec-[0021] In FIG. 1, the antenna has a structure in which tromagnetic waves with mutible frequencies and a ground potential point, a second one-port resonant dring conductor 1 and a ground potential point, and a point at which the radisting conductor 1 and the one-port rescult 3 is connected between the other end of the radialacteristic impedence 5 and a voltage source 8 is con-8 R

compatible with four frequencies can be realized by adopting either of the circuits of FIGS, 10B1 and 10B. as equivalent circuits, using reactance elements. That is, an equivalent circuit is formed by a resonant circuit ductance) element. Examples hereof are shown in FIGS. 10A1, 10A2, 10B1, and 10B2. As will be defrequencies can be realized by adopting either of the circuits of FIGS, 10A1 and 10A2 and a four-mode enterna and 1082 are equivalent circuit representations of resfor the number of frequencies that are supported by the [0022] The resonant circuits 2 and 3 are represented consisting of a C (capacitance) element and an L (inscribed later, a two-mode antenna compatible with two The circuit axamples of the FIGS, 10A1, 10A2, 10B1, onant circuits formed of a minimum number of alements 2 \$ 8

mittance equivalent to the characteristic impedance 5 in value having an absolute value approximately equaling cuit 3 are set to assume an admittance having a real the RF circuit and a specific imaginary part value and sign. The admittance with the susceptance value is set circuit 2 is connected in parallel with the RF circuit at the the radiating conductor 1 and the second resonant cirpart value approximately equaling a characteristic edthe first resonant circuit 2 is set to have a susceptance the specific imaginary part value, but with an inverse near a point A or B in FIG. 2, because the first resonant [0023] At the feeding point 4, for multiple frequencies 5 8 8

[8824] A circle on which the points A and B exist in FIG. 2 corresponds to the locus of the characteristic adfeeding point 4.

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nitiance represented as a pure resistance component oquivalent to the characteristic impedance, when the Smith chart is normalized by the characteristic imped-

ance 5 in the RF circuit.

1023] Thue, when the points A and B exist on the locus of the characteristic admittance, a good matching between the RF circuit and the multi-mode entenned the present invention can be achieved. Viewing from another prespective, in order to achieved. Viewing from astate between the RF circuit and the multi-mode antenned the present invention, it is required that the admittence with the susseptimos value be present near the locus of the characteristic admittance.

ionzal To make the entions of this embodiment oporate as the multi-mode antenna compatible with multiple carriers, for the froquencies of the carriers, it's required that the admittence be view from the feeding point
4 toward the nodiating-conductor 1 be present near the
point A or B in Fig. 2 and it is destrable that the admittence be present near the point A or B allormately betwoen A and B or B and A in the frequency increase
the point A ropresents a point in one semicircular portion
where the susceptiance value is positive of the characindraite admittance becas and the point B ropresents
and in the other semicircular portion where the suscaptiance value is negative. The reason hereof is de-

scribed with FIG. 3.

[0027] In the equivalent circuit representation of the first resonant circuit 2, according to placement of the C-dicapoclarico) and L (inductance) elements, the frequency characteristic of the susceptance of the first resonant circuit takes any form of the following: F and GI; F. Gi, and H; Gi and H; and GI only (let 12, ...). The frequency characteristic of the susceptance value (IB) of the first resonant circuit 2 appears in a monotonically increasing function which continues to increase along the frequency safe, as a shown in FIG. 3. This fact has along the proven from a relationship between a recitance bunction proven from a relationship between a recitance bunction or susceptance function and a Hurwitz

captane function alternates between pole and zero or captane function alternates between pole and zero or captane of poles and requesty increases. The number of poles and zeros has on-to-one correspondence to the number of the C and L elements in the equivalent circuit representation of the resonant circuit and one L-C pair generates one pole or zero. That is, the circuit of FIG. 1041 generates one pole and the circuit of FIG. 1042 generates one zero. One alternation occurs across the circuits of the FIGS. 1041 and 10Az and the combaniton of these circuits is compatible with two frequencies. Three alternations occur across the circuit is fixed in the circuit of FIGS. 1081 and 1082 and carcis step of FIGS. 1081 and 1082 and carcis step of FIGS. 1081 and 1082 and concellation with two frequencies.

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[0029] For the frequencles of multiple cerriers that the antenna of this embodiment should transmit and receive as the multi-mode entenna, when the admittance in view

from the feeding point 4 toward the radiating conductor is assumes whose alternating bowenes in the points A and B. the first reasonant circuit 2 that cancels out the susptance component circuit 2 that cancels out the susptance component of the admittance at these points A and B can be configured in the equivalent circuit representation with a minimum number of estimates. In this case, the sum of the number of poles and the number of 2 zeros in the equivalent circuit representation of the first reasonant circuit 2 will be equal to the number of the multiple frequencies. In this way, the first reasonant circuit can be designed to be smaller with lower loss and, consequently, the entenna can be downsized. Moreover, as is apparent from FIG. 3, abrupt impedance change in relation to an unwantel doole for the carriers with adjacent frequencies can be avoided and this produces an effect that the entenna isten as a whole has a broader

(9030) Thus, the present invention realizes good impedance matching between the RF dircuit and free spaces at the single feeding point 4 and the energy of the electromagnetic waves with multiple frequencies coming to the antenna of the present invention can be conducted to the RF circuit efficiently. The effect hereof is realizing a suitable multi-mode entenna for multimedia wireless paratrus that provides the user with a plurality of wheless information transmission services, using the carriers with different frequencies.

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ignastic Another embodinent of the present invention is described with FIGS. 4, 2, and 3. FIG. 4 is a structural diagram, showing the components of another multimode antenne embodiment of the present invention and their connections. Difference from the embodiment of FIG. 1 lies in the first one-port resonant circuit 2, one end of which not connecting to the readility conductor 1 directly stitaches to the feeding point 4 without the connection to a ground potential point, in this embodiment also, for the resonant circuits 2 and 3, the circuits shown in, e.g., FIGS. 1041, 10A2, 10B1, and 10B2 are em-

10022] At a connection point 140 between the first one-port resonant dircuit 2 and the radiating conductor 1, for multiple fraquencies, the radiating conductor 1 and the second resonant circuit a saurme an impedance having a real part value approximately equaling the characteristic impedance 5 in the RF circuit and a specific imaginary part value and the first resonant circuit 2 has a reseatance value having an absolute value approximately equaling the specific imaginary part value.

[0033] The impedance with the reactance value is set mear a point at or be HGJ. 2, because the first resonant decidal 2 is connected in series with the PG circuit at the leading point 4. A circuit on which the points a end b exist in FIG. 2 corresponds to the locus of the chere-teristic impedance represented as a pure resistance component equivalent to the characteristic impedance, when the Smith charlt is normalized by the characteristic impedance, impedance in the RF circuit.

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(1034) Thus, when the points a and b exist on the locus of the characteristic impedance, a goodmatching between the RF circuit and the multi-mode antenna of the present it went to see achieved. Viewing from another prespective, in order to exhieve the good matching state between the RF circuit and the multi-mode antenna of the present invention, it is required that the impedance which the reactance value be present near the locus of the characteristic impedance.

value is negative. The reason and affect hereof are the same as stated for the embodiment of FIG. 1. The sum where the reactance value is positive of the characterof the number of poles and the number of zeros in the equivalent circuit representation of the first resonant circult 2 will be equal to the number of the mutitple frequen-[0035] To make the antenna of this embodiment opquired that the impedance in view from the connection near the point a or b in FIG. 2 and it is desirable that the Impedance be present near the point a or b atternataly batween a and b or a and b in the frequency increase Istic Impedance locus and the point b represents a point In the other semichaular portion where the reactance erate as the multi-mode antenna compatible with multiple carriers, for the frequencies of the carriers, it is repoint 140 toward the radiating conductor 1 be present direction from one carrier frequency to another. Here, the point a represents a point in one semicircular portion

[0035] The effect of this embodiment is the same as the embodiment of FIG. I and, moreover, this embodiment of FIG. I and, moreover, this embodiment of FIG. I may be resilized by an equivalent drout with a smaller range of the values of the elements, when the imaginary part of the impedance that the realisting conductor I and the second resonant circuit 3 assume at the connection point 140 has a great absolute value.

[0037] Another embodiment of the present invention is described with FIG. 5, FIG. 5 is a structural diagram showing the components of snother multi-mode anterna embodiment of the present invention and their connections. Difference from the embodiment of FIG. 2 lies in that a third one-port resonent circuit 7 is inserted between the connection point 140 and a ground terminal terminal.

10039] In this embodiment, a four-mode enterna can be realized by realizing the second resonant drouti 3 according to, e.g., the equivalent circuit configurations of FIGS, 1091 and 1092 and by realizing the first reasonant circuit 2 and the third resonant circuit 7 according to, e.g., the equivalent circuit configurations of FIGS, 1041 and 1042. The sum of the number of potes and the number of zeros in the equivalent circuit topressentiations of the first one-port resonant circuit and the hird one-port resonant circuit and the hird one-port resonant circuit 2 and the hird one-port resonant circuit 2 and the number of most 140 will be equal to the number of multiple first configurations. The second this conformant is the supportation of the connection point 140 will be equal to the number of multiple infragrance and the connection point 140 will be equal to the number of multiple

(10039) The effect of this embodiment is the same as the embodiment of FIG. 1 and, moreover, this embodi-

ment has an effect that the third resonant circuit 7 can be realized by an equivalent circuit with a smaller range of the values of the elements, when the Inraginary part of the impedance that the radialing conductor 1 and the second reasonant charit 3 assume as the connection point 140 has an absolute value that changes, or increases or decreases, depending on the above multiple

[0040] Another embodiment of the present invention is described with FiG. 6, FiG. 6 is a structural dargram showing the components of another multi-mode antern a embodiment of the present invention and their connections. Difference from the embodiment of FiG. 5 its in that the second one-port resonant drout 3 is formed in that the second one-port resonant drout 3 is formed and, and a ground potential point. Again, his embodiment of FiG. 5 its end, and a ground potential point. Again, his embodiment is between a point along the radiality according to, e.g., the equivalent drout orangerations of FiGS, 1081 and 20 1082 and by realizing the first resonant drout 2 and the chiral configurations of FiGS, 1041 and 10A2.

[0041] The effect of this embodiment is the same as the embodiment of FIG. Sand, moreover, this embodiment of FIG. Sand, moreover, this embodiment ary part of the impedance that the redisting conductor 1 and the second resonant circuit 3 assume at the connection point 140 is restricted from changing, depending on the multiple frequencies to be supported by the anone may another first and third resonant circuits 2 and 7 can be realized by an equivalent circuit 2 and 7 can be realized by an equivalent circuit 2 and 7 can be values of the elements.

10042] Another embodiment of the present invention is described with FIG. 7. FIG. 7 is a structural diagram strowing the components of another multi-mode aniterna embodiment of the present invention and their connection. Difference from the embodiment of FIG. 5 lies in that a fourth one-port resonant circuit 8 is formed between one point and another point along the resonating conductor 1, in this embodiment, a fourth-one enterna can be realized by realizing the first bourth resonant circuits 2, 3, 7, and 8 according to, e.g., the equivalent circuit configurations of FIGS, 10A1 and 10A2.

10043) The effect of this embodiment is the same as the embodiment of FIG. 5 and, as is the case for the embodiment of FIG. 6, this embodiment has effects that the absolute value for the imaginary part of the timped-ance that the radiating conductor 1 and the second resonant circuit 3 assume at the connection point 140 is 80 restricted from changing, depending on the multiple frequencies to be supported by the antenna, and the first and third resonant circuits 2 and 7, can be realized by an equivalent circuits 2 and 7, can be realized by

10041 Another embodiment of the present invention is described with FIG. 8 is a structural diagram showing the components of enother multi-mode entern an embodiment of the present invention and their con-

the entenna, and the first and third resonant circuits 2 and 7 can be realized by an equivalent circuit with a ductor 1 and the second resonant circuit 3 assume at the embodiment of FIG. 7 and, even when the physical size of the radiating conductor 1 is small and it is hard to form two points between which the fourth resonant circuit 8 should be connected along the radiating conductor, as is the case for the embodiment of FIG. 7, this embodiment has effects that the absolute value for the Imaginary part of the impedance that the radiating conthe connection point 140 is restricted from changing, depending on the multiple frequencies to be supported by (0045) The effect of this embodiment is the same as smaller range of the values of the elements.

the other end of the radiation conductor 9 and a ground potential point. In this embodiment, a four-mode antenna can be realized by realizing the first to fourth resonant In that one end of the second one-port resonant circuit 3, the end not connecting to the radiation conductor 1, 10046] Another embodiment of the present invention is described with FIG. 9. FIG. 9 is a structural diagram Is disconnected from the ground potential point and attached to one end of a second radiating conductor 9 and a fourth one-port resonant circuit 8 is formed between circuits 2, 3, 7, and 8 according to, e.g., the equivalent showing the components of another multi-mode antenna embodiment of the present invention and their connections. Difference from the embodiment of FIG. 5 lies circuit configurations of FIGS, 10A1 and 10A2.

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radialing conductor of the antenna of the present invenresonant circuit 3 essume at the connection point 140 is restricted from changing, depending on the multiple frequencies to be supported by the antenna, and the first of the elements. Although an instance where the radialtion as a single continuous structure, as is the case for the embodiment of FIG. 7, this embodiment has effects pedance that the radiating conductor 1 and the second and third resonant circuits 2 and 7 can be realized by ing conductor is divided into two continuo bodies is presented in this embodiment, dividing it into two bodies is not always required and it is possible to divide it into three or more continuous bodies; even in this case, an lly be realized by analogy with the embodiments of this [0047] According to this embodiment, even when there is spatial limitation that makes it hard to form the that the absolute value for the imaginary part of the iman equivalent circult with a smaller range of the values antenna configuration having the same effects can easfigure and FIGS. 7 and 8.

Another embodiment of the present invention

above a ground substrate 11 with a gap of 3 mm from the ground substrate 11. Both ends of the rectangular plate portion are bent vertically toward the ground submately 3 mm and keeping e width of 1 mm in order not to bring the ptate portion in electrical contact with the as an example the configuration of the embodiment of FIG. 1. The radiating conductor 1 is formed by bending a 1 mm wide strip conductor and its rectangular plate portion which is 1 mm wide and 15 mm long is placed strate 11 to form extensions with a length of approxiis described with FIGS. 11A through 11C. FIG. 11A shows a design example of a small multi-mode antenna embodiment of the present invention; this design takes

the bent ends and the ground substrate and the second feeding point 4 is set up at the connection point at which are connected, also connecting to the RF circuit represented as the equivalent circuit consisting of the charons-port resonant circuit 3 is formed between the other end of the conductor 1 and the ground substrate. The the radiating conductor 1 and the first resonant circuit 2 The first one-port resonant circuit 2 is formed between one end of the strip radiating conductor 1 with acteristic impedance 5 and the voltage source 6. ground substrate. [0049] The first or

[0050] In this structure, by configuring the first resonant circuit 2 as an equivalent circuit that assumes sus-FIG. 11B and configuring the second resonant circuit 3 as an equivalent circuit that assume reactance |X| (Co = 0.0827 pF, Lo = 24.60 nH) shown in FIG. 11C, it was able to get benchvidths of 3% and 5% satisfying that Ver-Gai Standing Wave Ratio (VSWR) < 2, respectively, for ceptance JBs (Cs = 21.5pF, Ls = 0.169 nH) shown in carrier frequencies of 1 GHz and 2 GHz and to realize a two-mode antenna.

ductor structure is coupled to the resonant circuits. In this structure, by configuring the first resonant circuit 2 Standing Wave Ratio (VSWR) < 2, respectively, for car-rier frequencies of 1 GHz and 2 GHz and to realize a [0053] Another embodiment of the present invention is described with FIGS. 12A through 12C. FIG. 12A shows enother design exemple of a small multi-mode (Cs = 32.1pF, Ls = 0.593 nH) shown in FIG. 12B and Lo = 24.06 nH) shown in FIG. 12C, it was able to get bandwidths of 0.7% and 10% satisfying that Vertical sign takes as an example the same configuration as in the embodiment of FIG. 11, wherein the radiating conas an equivalent circuit that assumes susceptance JBs configuring the second resonant circuit 3 as an equivalent circuit that assume reactance JX (Co = 0.0885 pF, two-mode antenna in which a significant difference lies between the bandwidths to be supported by the antenna antenna embodiment of the present invention; this defor the above two carrier frequencies. \$ 2

showing the components of a small multi-mode antenna embodinent of the present invention and their connections. Difference from the foregoing embodiments lies [0052] Another embodiment of the present invention is described with FIG. 13. FIG. 13 is a structural diagram

the series connection of the characteristic impedance 5 and the voltage source 6 is represented as a single exin that the radiating conductor 1 incorporates ground potential integral with it in structure, in this embodiment, citer 12 for clarity of the drawing.

incorporates ground potential integral with it in this embodiment, one end of the first one-port resonant circuit 2 is coupled to one end of the exciter 12 at the feeding point 4, both ends of the series connection of the first nected to the radiating conductor 1 in a first gap 13, and both ends of the second one-port resonant circuit 3 are electrically connected to the radiating conductor 1 in a [0053] Because the plate-like radiating conductor 1 resonant circuit 2 and the exciter 12 are electrically consecond gap 14.

cause the enterns itself incorporates ground potential integral with It, this embodiment has the following effects: this entenna is allowed to operate independently RF circuit and its design can easily be made without tak-ing the influence of this circuit board into consideration; moreover, an enterna meets specifications requiring that the radiating conductor and the RC circuit be The equivalent circuit in this embodiment structure is equivalent to the embodiment of FIG. 4 and this embodiment can provide the same effect as the embodiment of FIG. 4. In this embodiment structure, beof a circuit board that provides ground potential to the prounded separately is realized.

that the radiating conductor 1 has a third gap 15 and the third one-port resonant circuit 7 is electrically connected is described with FIG. 14. FIG. 14 is a structural diagram 10055] Another embodiment of the present invention showing the components of a small multi-mode antenna embodiment of the present invention and their connections. Difference from the embodiment of FIG. 13 lies in to the radiating conductor 1 in the third gap 15.

ture has the following effects: it enables simple design without taking the influence of the RF circuit board into cetions requiring that the radiating conductor and the as the embodiment of FIG. 5 or FIG. 8. As is the case for the embodiment of FIG. 13, this embodiment struc-(0056) The equivalent circuit in this embodiment structure is equivalent to the embodiment of FIG. 5 or FIG. 8 and this embodiment can provide the same effect consideration and realizes an antenna meeting specif-RC circuit be grounded separately.

embodiment of the present invention and their conneclions. Difference from the embodiment of FIG. 14 lies in (9957) Another embodiment of the present invention s described with FIG. 15, FIG. 15 is a structural diagram showing the components of a small multi-mode antenna that the first gap is integral with a sift 16 which is formed

current near the exciter can be controlled by shaping the with frequency change at both ends of the series con-nection circuit of the first resonant circuit 2 and the ex-[0058] According to this embodiment, because the redisting conductor 1 with the siit 16, impedance change

conductor in this embodiment, it can easily be reasoned bandwidths for different multiple carrier frequencies can be expanded. Although the sill 16 is not closed in the EP 1 553 659 A1

by analogy that an enclosed, so-called slot shape can

yield the same effect.

the entenne structure is made up of a top layer 21 which forms the top surface, a left side surface 22, a right side surface 23, a front surface 24, an inflammediate layer 25 is described with FIG. 16. FIG. 16 is a diagram showing a small multi-mode antenna structure in which the invention is embodied, formed by employing a multilayer substrate, in relation to its fabrication method, wherein between layers, and a bottom layer 28 which forms the [0059] Another embodiment of the present invention 5

strate 27 constitting of a dielectric are formed. The in-termediate layer 25 may be formed on the top surface of the lower dielectric subtrates 27.

which forms the top layer pattern for the top layer 21 is which forms the top layer pattern for the top layer 21 is layer pattern for the intermediate layer 25 under the bot-tom surface of the upper dialectric substrate 28, a lower dielectric substrate 27 in contact with the intermediate tayer 25, and a bottom layer pattern for the bottom layer 26 under the bottom surface of the lower dielectric suba top layer pattern for the top layer 21, an upper dielectric substrate 28 consisting of a dielectric, on the top surface of which the top layer 21 ts placed, an intermediate [0060] To form this structure, by a multilayer process

strate 28 by a thick film process or thin film process. On a left side surface 22 portion of the upper dielectric sub-strate 28, a radiating conductor left side pattern 32 is printed by thick film or thin film process. On a right side a radiating conductor right side pattern 33 is printed by thick film or thin film process. On the intermediate layer 25 under the bottom surface of the upper dielectric substrate 28 (or on the top surface of the lower dielectric second spiral conductor pattern 42 which form the intermediate layer pattern are printed by thin film process. by thick film or thin film process. On the bottom layer 26 strate 27, a first strip ground conductor pattern 51 and a second strip ground conductor pattern 52 which form the bottom layer pattern are printed by thick film or thin printed on the top surface of the upper dielectric subsurface 23 portion of the upper dielectric substrate 28, substrate 27), a first spiral conductor pattern 41 and a On a left side surface 22 portion of the lower dielectric substrate 27, a feeding conductor pattern 34 is printed under the bottom surface of the lower dielectric sub-9 8

bottom surface of the upper dielectric substrate 28 and ed. For bonding, for example, the following method is (0062) After these patterns are printed as above, the the top surface of the lower dielectric substrate 27 are bonded together and the multilayer structure is completused; form a bonding layer on the bottom surface of the substrate 28 or the top surface of the substrate 27, place

dielectric substrate 27 may be identical or different. However, when they are different, it is preferable to make the permittivity of the upper dielectric substrate 28 dor to decrease the coupling between the radiating conductor patterns 41, 42 and increase the efficiency of radiation of electromagnetic waves from the radialing conductor patterns (0064) In the structure of this embodiment, permittivity lower than that of the lower diefectric substrate 27 in orof the upper diefectric substrate 28 and that of the lower 31, 32, 33 to free space.

strate 27.

magnetic substrate lower than that of the lower magnet-(0083) Moreover, in this embodiment, it is possible to roplace the upper dielectric substrate 28 and the lower dielectric substrate 27, respectively, with upper and lower magnelic substrates made of a magnetic substance. strate and that of the lower magnetic substrate may be identical or different. However, when they are different, it is preferable to make the permeability of the upper in that event, permosbility of the uppor magnetic subic substrate.

Ing the first and second strip ground conductors 51, 52 to the ground potential of the RF circuit, the structure of [0066] In this embodiment structure, the equivalent be realized with the spiral conductors 41, 42 and the circuit representations of resonant circuit structures can through holes 44. By setting up the feeding point anywhere in the feeding conductor pattern 34 and connectthe embodiment of the FIG. 1 can be realized.

[0087] Therefore, according to this embodiment, the multi-mode antenne in which the invention is embodied quently, downsizing the multi-mode antenna and cost can be fabricated by way of multilayor process; consereduction by manufacturing aconomy of scale are

Another embodiment of the present invention is described with FIG. 17. FIG. 17 is a diagram showing a small multi-mode antenna structure in which the in-

ubstrate 27, a shleiding conductor front surface pattern

ars, a sacond intermediate layer 25b between layers, a bottom layer 26 which forms the bottom surface, and a vention is embodied in relation to its multitayer substrate up of a top layer 21 which forms the top surface a left side surface 22, a right side surface 23, a front surface 24, a first intermediate layer 25a between lay-

bottom layer pattam for the bottom layer 26 under the bottom surface of the lower dielectric substrate 27 are strate 29 and the second intermediate layer 25b may be formed on the top surface of the lower dielectric subunder the bottom surface of the upper dielectric substrate 29, an intermediate dielectric substrate 29 in concontact with the second intermediate layer 25b, and the rear surface 30. [0069] To form this structure, by multilayer process, lectric substrate 28 consisting of a dielectric, on the top mediate layer pattem for the first intermadiate layar 25s tact with the first intermediate layer 25a, a second intermediate tayer pattern for the second intermediate tayer 25b under the bottom surface of the intermediate dielectric substrate 29, the lower dielectric substrate 27 in formed. The first intermediate layer 25a may be formed on the top surface of the Intermediate dielectric subthe top layer pattarn for the top layer 21, the upper diesurface of which the top layer 21 is placed, a first inter(0070) The radiating conductor top layer pattern 31, which forms the top layer pattern for the top layer 21 is strate 28 by thick film or thin film process. On left side surface 22 portions of the upper dielectric substrate 28 and intermediate dielectric substrate 29, the radiating conductor left side pattern 32 is printed by thick film or thin film process. On right side surface 23 portions of pattern 33 is printed by thick film or thin film process. On the first intermediate layer 25s under the bottom surface printed on the top surface of the upper dielectric subthe upper diefectric substrate 28 and intermediate dieteciric substrate 29, the radiating conductor right side of the upper dielectric substrate 28 (or on the top surface of the Intarmediate dielectric substrate 29), a shielding conductor top surface pattern 53 which forms the first intermediate pattern is printed by thin film process. On the second intermediate layer 25b under the bottom surface of the intermediate dielectric substrate 29 (or on the top surface of the lower dielectric substrate 27), the layer pattern are printed by thin film process. On a left a shielding conductor bottom surface pattern 58 which thin film process. On front surface 24 portions of the infirst spiral conductor pattern 41 and second spiral conductor pattern 42 which form the second intermediate side surface 22 portion of the lower dielectric substrate 27, the feeding conductor pattern 34 is printed by thick film or thin film process. On the bottom layer 26 under the bottom surface of the lower dielectric substrate 27, termediate diefectric substrate 29 and lower diefectric ä 8

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printed by thick film or thin film process. On rear strate 29 and lower dielectric substrate 27, a shletding conductor rear surface pattern 55 is printed by thick film

se 30 portions of the intermediate dielectric sub-

illayer process); consequently, downstaing the muttaconomy of scale can be achieved. As compared to the tromagnetic coupling between the radiating conductor and the resonant circults is significantly suppressed, In this embodiment structure, as is the case for the embodiment of FIG. 16, the structure of the embod-Iment of the FIG. 1 can be realized and the multi-mode antenna in which the invention is embodied can be fabricated by multilayer substrate fabrication method (mulmode antenna and cost reduction by manufacturing embodiment of FIG. 16, in this embodiment, the elecwhich yields an effect that design of the resonant circuits of the lower dielectric substrate 27 are bonded together, and the mutiliayer structure is completed. For bonding, for example, the following method is used: forming 29 are bonded together and the bottom surface of the intermediate dielectric substrate 29 and the top surface

bottom surface of the upper dielectric substrate 28 and the top surface of the intermediate dielectric substrate

[0071] After these patterns are printed as above, the

is described with FIG. 18. FIG. 18 is a diagram showing fabrication method, wherein the antenna structure is 24, intermediate layer 25 between layers, and bottom ayer 28 which forms the bottom surface, as is the case [0076] Another embodiment of the present invention a smatt mutti-mode antenna structure in which the invention is embodied in relation to its muitilayer substrate made up of the top layer 21 which forms the top surface, left side surface 22, right side surface 23, front surface for the embodiment of FIG. 16.

[0072] In the multileyer structure, the following electrical joints are formed. The radiating conductor top layer pattern 31, the radiating conductor left alde pattern 32,

and pressure to bond them together:

and the radiating conductor right side pattern 33 are Joined electrically. The radiating conductor left side pat-

tem 32 and the first spiral conductor pattern 41 are joined electrically. The radiating conductor right side pattern 33 and the second spiral conductor pattern 42

are joined electrically. The feeding conductor pattern 34 and the radiating conductor left side pattern 32 are joint of electrically. The list speta conductor pattern 41 and the shedring conductor bottom auritace pattern 56 are electrically joined via the first through hole 43 which is

formed through the lower dielectric substrate 27. The second spiral conductor pattern 42 and the shlalding joined via the second through hole 44 which is formed through the lower dielectric substrate 27. The shielding conductor front surface pattern 54 is electrically joined

conductor bottom surface pattern 56 are electrically

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28 or the top surface of the substrate 29 and on the bot-

bonding layers on the bottom surface of the substrate tom surface of the substrate 29 or the top surface of the substrate 27, pile these substrates, and applying heal

high frequency range of a GHz band and above, the width of the meandering conductors can be wider than in that the spiral conductors 41 and 42 are replaced with andering conductors, in an instance where the antenna In which the invention is embodied is applied to a ultrahe width of the spiral conductors and, thus, the resistduced, which yields an effect that the antenne efficiency [0077] Difference from the embodiment of FIG. 16 lies meandering conductors 45, 46. By adoption of the meance loss of the conductors in this section can be reis enhanced.

(0078) Another embodiment of the present invention is described with FIG. 19. FIG. 19 is a diagram showing fabrication method, wherein the antenna structure is made up of the top layer 21 which forms the top surface, left side surface 22, right side surface 23, front surface Intermediate layer 25b between layers, bottom layer 26 which forms the bottom surface, and rear surface 30, as a small multi-mode antenna structure in which the invention is embodied in relation to its mutitiayer substrate 24, first intermediate layer 25a between layers, second \$ 2

to the shielding conductor top surface pattern 53 and the shielding conductor bottom surface pattern 58. The

shielding conductor rear surface pattern 55 is electrically joined to the shialding conductor top surface pattern 53 and the shielding conductor bottom surface pattern 10073] In the structure of this embodiment also, the permitthily values of the upper dielectric substrate 28, lower dielectric substrate 27, and intermediate dielectric

substrate 29 may be identical or different. However, when they are different, it is preferable to make the per-

meandering conductors 45, 46. As compared to the embodiment of FIG. 17, when the antenna in which the in-[0079] Difference from the embodiment of FIG. 17 lies in that the spiral conductors 41 and 42 are replaced with vention is embodied is applied to an ultra-high frequency ranga of a GHz band and above, this embodiment yields an effect that the antenna efficiency is anhanced, similar to the effect of the embodiment of FIG. 18 in comparison is the case for the embodiment of FIG. 17. to the embodiment of FIG. 16.

Moreover, in this embodiment, it is possible to

mittivity of an upper-layer dielectric substrate lower.

replace the upper dielectric substrate 28, tower dielectric substrate 27, and intermediate dielectric substrate 29, respectively, with upper, lower, and intermediate magnetic substrates made of a magnetic substance. In that event, the permeability values of the upper, lower,

and intermediate magnetic substrates may be identical or different. However, when they are different, it is prefsrable to make the permeability of an upper-layer mag-

[0080] Another embodiment of the present invention is described with FIG. 20. FIG. 20 is a diagram showing a small multi-mode antenna structure in which the in-

to the radiating conductor left side pattern 32, the first where in the feeding conductor 34 and connecting the [0081] Difference from the embodiment of FIG. 16 lies colned to the first strip conductor 53, in the structure of tal of the RF circult, the structure of the embodiment of he FIG. 4 can be realized. Therefore, according to this embodiment, the multi-mode antenne in which the invention is embodied can be fabricated by multilayer in that the feeding conductor 34 is not electrically joined strip ground conductor 51 is replaced with a strip conductor 53, and the feeding conductor 34 is electrically this embodiment, by setting up the feeding point enysecond strip ground conductor 52 to the ground potenprocess and, consequently, downstzing the multi-mode antanns and cost reduction by manufacturing economy of scale can be achieved.

ieff side surface 22, right side surface 23, front surface 24, intermediate layer 25 between layers, and bottom layer 26 which forms the bottom surface, as is the case [0082] Another embodiment of the present invention is described with FIG. 21. FIG. 21 is a diagram showing a smell multi-mode antenna structure in which the Invention is embodied in relation to its multilayer substrate fabrication method, wherein the entenne structure is made up of the top layer 21 which forms the top surface, for the embodiment of FIG. 20.

in that the spiral conductors 41 and 42 are replaced with en effect that the antenne efficiency is enhenced, similar to the effect of the embodiment of FIG. 18 in comparison [0083] Difference from the embodiment of FIG. 20 lies meandering conductors 45, 48. As compared to the embodiment of FIG. 20, when the antenna in which the invention is embodied is applied to an ultra-high frequency range of a GHz band end above, this embodiment yields to the embodiment of FIG. 16.

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22B are diagrams showing a structure of an RF module (0084) Another embodiment of the present invention s described with FIGS. 22A and 22B. FIGS. 22A and equipped with a multi-mode antenna, wherein the invention is embodied; these diegrams are, respectively, a top view and a bottom view of the RF module.

consisting of a single layer or multiple layers, e small On the front surface of an RF substrate 101 mult-mode antenna 102 of the present invention and e RF multi-contact switch 103 are placed on the same

power amplifier (PA) 112a (112b, 112c) are concatenated in order from e transmit signel input terminal 123a (123b, 123c). A receive circuit (Rx) 115a (115b, 115c) and a low noise amplifier (LNA) 114a (114b, 114c) are A transmit circuit (Tx) 113a (113b, 113c) and a

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[0087] A first ground conductor 104 which is formed minal 125e (125b, 125c). A first branch output of the output to the low noise amplifier (LNA) 114a (114b, 114c) In a plane conductor pattern is formed on the front surface of the RF substrate 101 and a second ground conductor 105 which is formed in a plane conductor pattern concatenated in order from a receive signal output ter power emplifier 112a (112b, 112c) and a second branch are connected to a duplexer (DUP) 111a (111b, 111c). is formed on the reverse side.

101, first ground terminals 107, second ground terminals 120, power source terminals 121 for power amplinais 124 for receivers, receive circuit output terminais 125, a power source terminal 106 for RF multi-contact switch, and en RF multi-contact switch control terminal [0055] On the circumferences of the RF substrate fiers, power source terminals 122 for transmit circuits transmit signal input terminals 123, power source termi-108 are disposed.

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point of the multi-mode antenna 102 is connected to a common contact of the RF multi-contact switch 103 and Individual contacts of the RF multi-contact switch 103 [0089] A ground termins of the multi-mode antenna 102 is electrically connected to the first ground conductor 104 thet encloses the multI-mode enterne. A feeding are connected to common branch inputs of the duplexers 111a (111b, 111c).

switch 103 is electrically connected to the second ground conductor 105 via a through hole 131. Ground 114a (114b, 114c), and receive circuits 115a (115b, [0090] A ground terminal of the RF multi-contact terminals of the power amplifiers 112a (112b, 112c) transmit circuits 113e (113b, 113c), low noise emplifiers 115c) are electrically connected to the second ground conductor 105 via through holes 132.

to the first ground conductor 104 and the second ground conductor 105 and the second ground terminals 120 are The first ground terminals 107 are connected connected to the second ground conductor 105.

122a (122b, 122c) for transmit circuits are connected to piffers are connected to the power source sections of the power amplifiers 112a (112b, 112c) by a sultable wiring conductor pattern and the power source terminals the power source sections of the transmit circuits 113a (113b, 113c) by a suitable wiring conductor pattern. The power source terminals 124a (124b, 124c) for receivers are connected to the power source sections of the recontact switch and the RF multi-contact switch control [0092] The power source terminals 121 for power emceive circuits 115a (115b, 115c) and the low noise amplifiers 114a (114b, 114c) by a sultable wiring conductor pattern. The power source terminal 106 for RF multiterminal 108 are, respectively, connected to the power source section and the control signal input section of the RF multi-contact switch 103 by a suitable wiring conduc[0093] As for the units, namely, the duplexers 111, power amplifiers 112, transmit circuits 113, low noise

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amplifiers 114, and receive circuits 115, and as for the system are assumed to use three carrier frequencles and these units and terminals in sets of three (a, b, c) terminals, namely, the power source terminals 121 for source terminals 124 for receivers, and receive circuit vide information transmission services to be handled by power ampliflers, power source terminals 122 for transmit circuits, transmit signal input terminals 123, power output terminals 125, a plurality of these units and terminals as many es the number of carrier frequencies are mounted on the RF substrate 101, wherein the carrier frequencies are used by a wheless system to prohe RF module equipped with the multi-mode antenna of this embodiment. In this embodiment, the wireless

generally required to handle signals with a wide spec-trum of frequencies from LF (fow frequency) circuits that control man-machine interfaces to RF circuits that genviding information transfer by wireless communication ess information transmission services to the user, it is (0094) This RF module structure is a variant of the module that applies for a case where the system prouses a FDD (Frequency Division Multiple Access) syslem. For wireless apparatus capable of providing wiresrate and radiate electromagnetic waves.

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8 0095] Especially, for RF chruits, a different form of ufactured from high-priced substances with low loss realization from realizing LF circuits and IF (intermediate frequency) circuits is required, involving as short a wiring length as possible by using a costly substrate manproperties and the use of a number of shielding layers for reducing electromagnetic interference from wiring patterns on the substrate, atc. in view of loss in terms of material constants, circuit performance deteriorated by stray components, and others. For this reason, a genand manner is applied in which RF circuits are manufactured in modules end constructed separately from other LF and IF circuits and the RF modules are mountad on a circuit board on which the LF and IF circuits are elso mounted.

(0096) In prior art, because an antenna capable of multi-mode operation at a single feeding point has not been found, it was needed to mount a plurality of costly RF modules on a circuit board where LF and IF circuits are also mounted and this was a major factor of increasing the cost of wiring apparatus equipped with the RF modules. A plurality of RF modules ere scattered across the circuit board and this requires long wiring of RF signal lines and power source lines for power amplifiers, which caused e problem in which unwanted radiation of electromagnetic waves emitted by these lines deterio-

sible to integrate RF circuits that process multiple carriars into a singe RF module; this yields effects of reducng multimedia wireless apparatus manufacturing costs 0098] Another embodiment of the present invention [0097] According to this embodiment, it becomes posimproving the apparatus sensitivity.

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contact switches 118 and power is supplied from the power source terminals 128 for RF two-contact switches to the RF two-contact switches 116 by a suitable wiring is described with FIGS. 23A and 23B. FIGS. 23A and 23B are diagrams showing another structure of an RF module equipped with a multi-mode anterna, wherein the invention is embodied; these diagrams are, respecpower source terminals 126 for RF two-contact switches are attached to the circumferences of the RF substrate 101 to supply power for the operation of the RF twoand 22B lies in that RF two-contact switches 116 are employed instead of the duplexers 111 and that new tively, a top view and a bottom view of the RF module conductor pattern and a through hole 133. 2

[0100] This RF module structure is a variant of the module that applies for a case where the system providing information transfer by wireless communication uses a TDD (Time Division Multiple Access) system. The effects of this embodiment are the same as those of the embodiment of FIGS. 22A and 22B.

the TDD system can be more relaxed than those for the duplexers enabling the FDD system and, therefore, the former can be realized in smaller dimensions. Thus, this [0101] In general, the specifications of filters for use in the circuity of the RF two-contact switches enabling embodiment also yields affects of downsizing the RF module equipped with the multi-mode antenna, wherein the invention is embodied, end, moreover, downstring the wireless apparatus using the module. 52 8

duplexers should be employed in circuit blocks for the former and the RF two-contact switches in circuit blocks [0102] When the wireless apparatus supports a plurally of information service systems, some of which are FDD and other of which are TDD, it is self-evident that for the latter from retation to the embodiment of FIGS. 22A and 22B.

is described with FIGS. 24A and 24B. FIGS. 22A and module equipped with a multi-mode antenna, wherein the invention is embodied; these diagrams are, respec-Difference from the embodiment of FIGS, 22A ductor 105, corresponding to the region where the multi-[0103] Another embodiment of the present Invention 228 are diagrams showing enother structure of sn RF and 22B lies in that a portion of the second ground conmode anterna 102 is mounted on the RF substrate 101, tively, a top view and a bottom view of the RF module. [0104] \$ ÷

es those of the embodiment of FIGS. 22A and 22B. In this embodiment, unless the muttl-mode entenns 102 has one-sided directivity, the multi-mode entenna can radiate electromagnetic waves as well in the direction of the reverse side of the RF substrate 101. Thus, this embodiment yields an effect of enhancing the gain of the multi-mode antenna and, in consequence, an effect of enhancing the sensitivity of the wireless apparatus [0105] The effects of this embodiment are the same using the RF module equipped with the multi-mode an-8

enne of this embodiment.

Industrial Applicability

2 in an information system that provides a plurality of information transmission services by using cerriers with [0107] As implied above, the present invention is suitable for being applied to multimedia wireless apparatus multiple frequencies, such as, e.g., mobile wireless terminals such as multi-modemobile phones and personal handy phones (PHS), wireless LAN terminals, or comslex terminals having these multiple functions.

Claims

A multi-mode antenna comprising:

- a second one-port resonant circuit connected a first one-port resonant circuit connected to to the other end of the radiating conductor, and a radiating conductor which radiates electromagnetic waves with a plurality of frequencies, one end of the radiating conductor,
 - a single feeding point which is common for the plurally of frequencies and connected to the Irst one-port resonant circuit.
- wherein said first one-port resonant circuit is one-port resonant circuit is connected between the connected between one end of sald radiating conductor and a ground potential point, said second other and of said radiating conductor and the ground potential point, and said feeding point is a connection point at which the first one-port resonant circuit and the one end of the radiation conductor The multi-mode entenna according to claim 1, are connected.
- ductor and said feeding point, and said second one-port resonant circuit is connected between the other wherein said first one-port resonant circuit is connected between one end of said radiating conend of said radiating conductor and the ground po-The multi-mode antenna according to claim 1,

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- one and of said radiating conductor and said fead-ing point, and said second one-port resonant droult is connected between the other and of said radiatcomprising a third one-port resonant circuit ther comprising a third one-port resonant circult connected between one end of said radiating conductor and the ground potential point, wherein said first one-port resonant circuit is connected between The multi-mode entenna according to claim 1, furing conductor and the ground potential point.
- wherein an imaginary part of admittance or aling conductor toward the radiating conductor has etive signs with frequency increase in said plurality Impedance in view from said one end of said radia value which alternates between positive and neg-The multi-mode antenna according to claim 1, of frequencies.

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- wherein said radiating conductor is a single The multi-mode antenna according to claim 1, continuous body including ground potential. œ
- wherein said radiating conductor is spatially divided into parts which are electrically connected The multi-mode antenna according to claim 1, by a one-port resonant circuit.

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wherein the sum of the number of poles and the number of zeros in an equivalent circuit representation of the first one-port resonant circuit connected to said one end of said radiating conductor is equal to the number of said plurelity of frequen The multi-mode antenna according to daim 1, æ,

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said third one-port resonant circuit connected to said one end of said radiating conductor is equal to wherein the sum of the number of poles and tations of said first one-port resonant circuit and the number of zeros in equivalent circuit represen-The multi-mode antenna according to claim 4, the number of said plurality of frequencies. ë

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A multi-mode entenna comprising:

megnetic waves with a plurelity of frequencies, a first one-port resonant circuit connected to e single feeding point which is common for the a second one-port resonant circuit connected a radiating conductor which radiates electroto the other end of the radiating conductor, one end of the radiating conductor,

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phrality of frequencies and connected to the a multilayer structure of a laminate of a plurality of substrates comprising top, intermediate and first one-port resonant circuit, and oottom layers.

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wherein a part of the radiating conductor is formed on the top layer, the first one-port resonant circuit end the second one-port resonant circuit are formed on the intermediate layer, the feeding point is formed on a side surface of the multilayer structure, and a ground conductor having ground potertlal is formed on the bottom tayer.

- 5 and a shielding conductor to suppress electromagnetic coupling between said radiating conductor said second one-port resonant circuit is formed on and said first one-port resonant circuit as well as wherein another intermediate layer is formed between said top tayer and said intermediate layer 11. The multi-mode antenna according to claim 10, the another intermediate layer.
- wherein said shielding conductor is electrical-The multi-mode antenna according to claim 11, ly connected to the ground potential.

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- 2 The multi-mode antenne according to claim 10, wherein said first one-port resonant circuit and said second one-port resonant circuit are formed as spiral conductors.
- and said second one-port resonant circuit are wherein said first one-port resonant circuit 14. The multi-mode antenna according to claim 10, formed as meandering conductors.
- 8 comprising dielectric substances and magnetic of a radio frequency material selected from a group wherein said plurality of substrates are made The multi-mode antenna according to claim 10, substances.
- \$ wherein, when said plurality of insulating substrates are made of a dielectric substance, the plueach other and the permittivity of an upper-layer rality of substrates have different permittivity values substrate is lower than that of a lower-layer sub-The multi-mode antenna according to claim 15,
- wherein, when said plurality of insutating substrates are made of a magnetic substance, the plurailty of substrates have different permeability valuss each other and the permeability of an upperlayer substrate is lower than that of a lower-layer 17. The multi-mode antenna according to claim 15,

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comprising a radiating conductor which radiates electromagnetic waves with a plurelity of frequencies, a first one-port resonant circuit connected to one end of the rediating conductor, a second one-18. A method for fabricating a multi-mode antenna

port resonant circuit connected to the other end of which is common for the plurality of frequencies and the radiating conductor, and a single feeding point connected to the first one-port resonant circuit, the method comprising the steps of: forming a part of the radiating conductor on a top layer on the top surface of an upper substrate by film forming process;

forming the first one-port resonant circuit and

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termediate layer under the bottom surface of tial on a bottom layer under the bottom surface forming a conductor including the feeding point on a side surface of the lower substrate by film the second one-port resonant circuit on an informing a ground conductor with ground potenof a lower substrate by film forming process; the upper substrate by film forming process;

bonding the bottom surface of the upper substrate and the top surface of the lower substrate to form a multilayer structure. forming process; and

19. A RF module comprising:

facts as the number of a plurality of frequencles, the RF multi-contact switch being conan RF multi-contact switch with as many connected to a single feeding point of the mutila multi-mode antenna as recited in claim 1, mode antenna,

nected to the contacts of the RF multi-contact a plurality of circuit blocks respectively conswitch, and

a single-layer or multilayer RF substrate,

il-contact switch, and the plurality of circuit blocks wherein the multi-mode antenna, the RF mulare mounted on the RF substrate,

to one terminal of the duplexer, a transmit circuit connected to the power amplifier, a low noise am-pilifer connected to the other terminal of the duplexwherein each of the plurality of circuit blocks comprises a duplexer, a power amplifier connected er, and a receive circuit connected to the low noise amplifier, and

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wherein a plurality of common branch outputs of the duplexers corresponding to the plurality of circult blocks are connected via the RF multi-contact switch to the single feeding point of the antenna.

20. A RF module comprising:

tacts as the number of a plurality of frequen-cies, the RF multi-contact switch being conan RF multi-contact switch with as many connected to a single feeding point of the multia multi-mode antenna as recited in cletm 1,

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mode antenna, • plurality of circuit blocks respectively con-nected to the contacts of the RF multi-contact switch, and

a single-layer or multilayer RF substrate,

wherein the multi-mode antenna, the RF mul-ti-contact switch, and the plurality of circuit blocks are mounted on the RF substrate, wherein each of the plurality of circuit blocks 10 comprises an RF two-contact switch, a power am-pilifer connected to one terminal of the RF two-coner amplifier, a low notes amplifier connected to the other terminal of the RF two-contact switch, and a receive circuit connected to the low notes amplifier, tact switch, a transmit circuit connected to the powand and

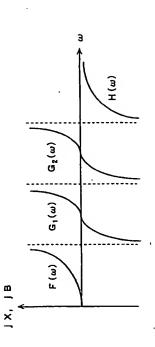
of the RF two-contact switches corresponding to the plurality of circuit blocks are connected via the RF 20 multi-contact switch to the single feeding point of wherein a plurality of common branch outputs

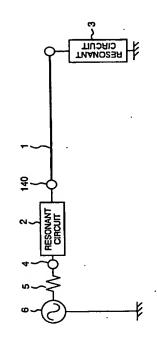
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PRESONANT CIRCUTT P CIRCUIT S

FIG. 2

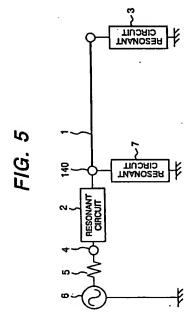




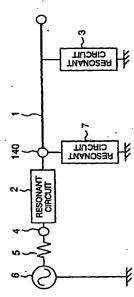


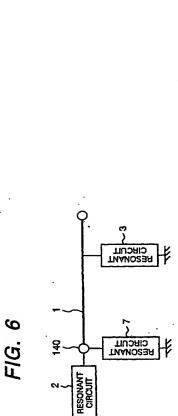
F/G. 4

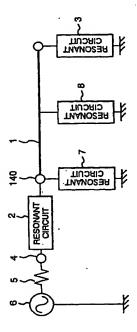
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F/G. 8







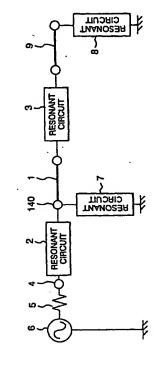


FIG. 9

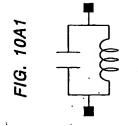


FIG. 10B1

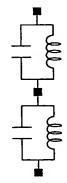


FIG. 10B2

FIG. 10A2

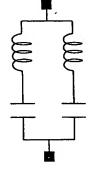


FIG. 11A

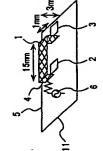


FIG. 11B



FIG. 11C



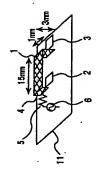
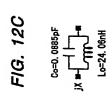


FIG. 12B







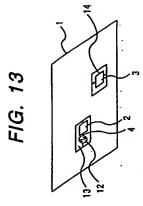
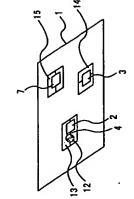
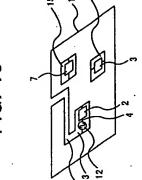
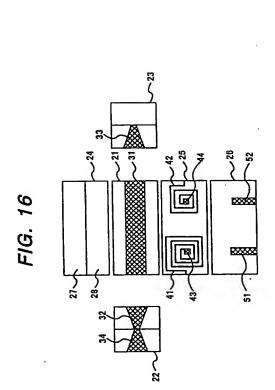


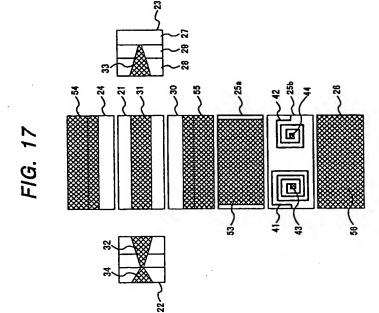
FIG. 14

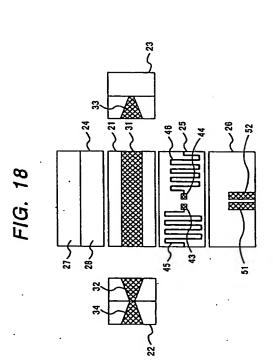


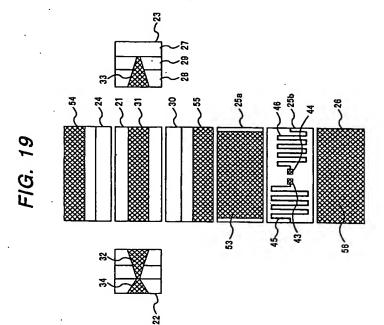
F/G. 15





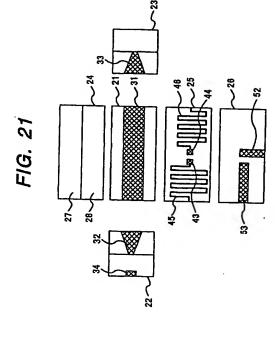






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F/G. 20

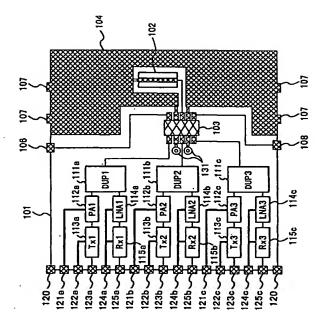


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FIG. 22A



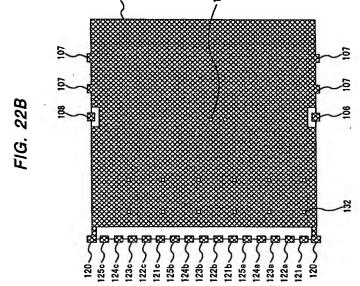
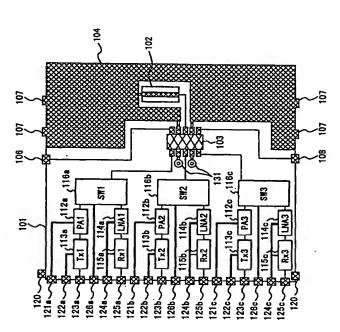


FIG. 23A



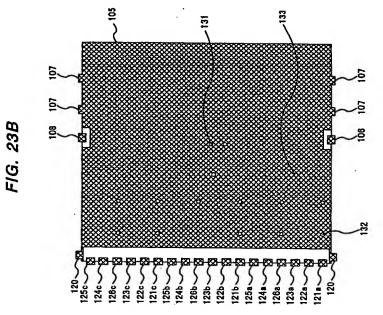


FIG. 24A

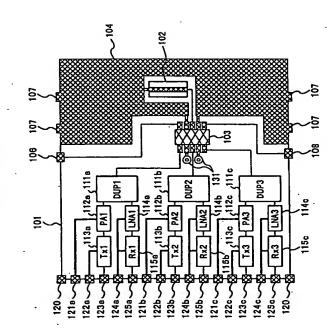


FIG. 24B 1218 1248 122c

125b 124b

123b

122b

1216

125a

1230

120

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4	EP 1202383 A2 (Mitsubishi Materials 02 May, 2002 (02.05.02), Full text, all drawings c US 2002/0118143 A1 c UP 2002-20	terials Corp.),	1-20
4	JP 2002-300081 A (Kyocera Co 11 October, 2002 (11.10.02), Full text, all drawings (Family: none)	Corp.),	1-20
«	JP 9-83232 A (Hitachi, Ltd.), 28 March, 1997 (28.03.97), Full text, all drawings (Family: none)		1-20
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